

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Pak Shing Leung	09/19/2012
RECEIVING PARTY DATA	
Name:	Syba Tech Limited
Street Address:	21-33 Tai Lin Pai Road
Internal Address:	Room 12, 13/F, Vanta Industrial Centre
City:	Kwai Chung, New Territories, Hong Kong
State/Country:	CHINA
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13989667
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ATTORNEY DOCKET NUMBER:	EMI001 P303
NAME OF SUBMITTER:	Todd A. Van Thomme
Signature:	/Nathan's Dad/
Date:	05/24/2013
Total Attachments: 1 source=Assignment (2)#page1.tif	

OP \$40.00 13989667

**ASSIGNMENT**

WHEREAS, Pak Shing Leung residing at Room 12, 13/F, Vanta Industrial Centre, 21-33 Tai Lin Pai Road, Kwai Chung, New Territories, Hong Kong, respectively (hereinafter referred to as Assignor), has invented certain new and useful improvements in **HARD DISC ENCLOSURE** for which an application for United States Letters Patent is attached hereto.

WHEREAS, Syba Tech Limited a corporation of China, having a place of business at Room 12, 13/F, Vanta Industrial Centre, 21-33 Tai Lin Pai Road, Kwai Chung, New Territories, Hong Kong, (hereinafter referred to as Assignee) is desirous of acquiring the entire right, title and interest in and to any invention arising from said disclosed subject matter and in and to any Letters Patent that may be granted therefor in the United States and in any and all foreign countries.

NOW, THEREFORE, in consideration of the sum of one dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable considerations, Assignor hereby sells, assigns and transfers unto said Assignee the full and exclusive right, title and interest to the said invention in the United States and in all foreign countries and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States and in any and all foreign countries and in and to any and all divisions, reissues, continuations, continuation-in-part, and extensions thereof including the full right to claim for any such applications the benefits of the International Convention, and including the right to obtain a reasonable royalty pursuant to 35 U.S.C. § 154(d) upon publication of any such United States applications.

Assignor hereby authorizes and requests the Patent Office Officials in the United States and in any and all foreign countries to issue any and all of said Letters Patent, when granted, to said Assignee as the owner of the entire right, title and interest in and to the same, for the sole use and benefit of said Assignee, its successors and assigns.

FURTHER, Assignor agrees to communicate to said Assignee or its representatives any facts known to Assignor respecting said subject matter, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, continuation-in-part, substitution, renewal, and reissue applications, as well as all subsequently filed applications claiming priority thereon, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said Assignee, make all rightful oaths and generally do everything possible to aid said Assignee, its successors and assigns, to obtain and enforce proper protection for any invention arising from said disclosed subject matter in the United States and in any and all foreign countries.

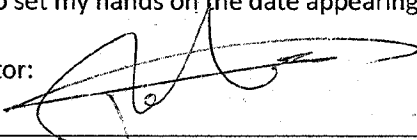
IN TESTIMONY WHEREOF, I have hereunto set my hands on the date appearing next to my signature.

Witness:



WONG, Po Chuen

Inventor:



LEUNG, Pak Shing

Date:

SEPT 19 2012